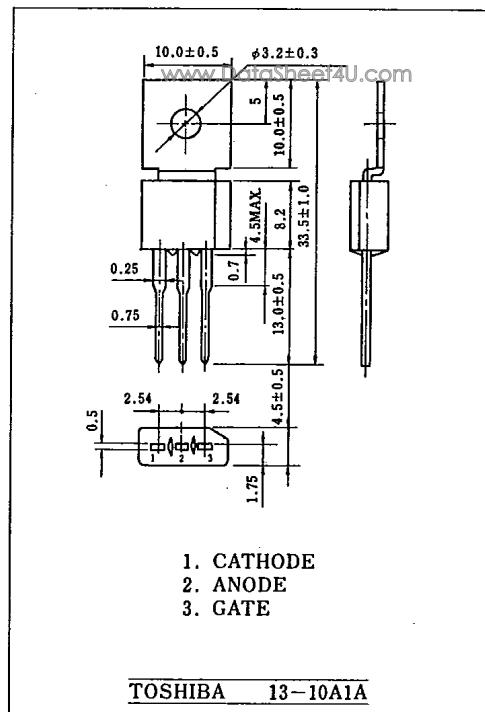


SH2G41

400V 2A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	SH2B41	V _{DRM}	V
	SH2D41	200	
	SH2G41	400	
Non-Repetitive Peak Reverse Voltage (Non-Rep <5ms) T _j =0~110°C	SH2B41	150	V
	SH2D41	300	
	SH2G41	500	
R.M.S On-State Current	I _{T(RSM)}	3.1	A
Average On-State Current (Half Sine Waveform T _c =35°C)	I _{T(AV)}	2.0	A
Peak One Cycle Surge On-State Current (Non-Repetitive)	I _{TSM}	22(60Hz)	A
		20(50Hz)	
I ² t Limit Value (t=1ms~10ms)	I ² t	1.6	A ² s
Peak Gate Power Dissipation	P _{GM}	0.5	W
Average Gate Power Dissipation	P _{G(AV)}	0.05	W
Peak Forward Gate Current	I _{GM}	150	mA
Peak Reverse Gate Voltage	V _{RGM}	-5	V
Junction Temperature	T _j	-40~110	°C
Storage Temperature Range	T _{stg}	-40~110	°C



ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	I _{DRM} and I _{RRM}	V _{DRM} =V _{RRM} =Rated, T _j =110°C, R _{GK} =1kΩ	—	—	200	μA
Peak On-State Voltage	V _{TM}	I _{TM} =10A, T _c =25°C	—	—	2.2	V
Gate Trigger Voltage	V _{GTR}	V _D =6V, R _L =100Ω, R _{GK} =1kΩ, T _c =25°C	—	—	0.8	V
Gate Trigger Current	I _{GT}	V _D =6V, R _L =100Ω, R _{GK} =1kΩ, T _c =25°C	—	—	1500	μA
Gate Non-Trigger Voltage	V _{GDN}	V _D =Rated, R _{GK} =1kΩ, T _c =25°C	0.2	—	—	V
Critical Rate of Rise of Off-State Voltage	dv/dt	V _{DRM} =Rated, R _{GK} =1kΩ, Exponential rise, T _j =110°C	20	—	—	V/μs
Holding Current	I _H	R _L =100Ω, R _{GK} =1kΩ, T _c =25°C	—	12	—	mA
Turn-Off Time	t _q	V _D =Rated, I _F =10A, t _w =10μs dv/dt=20V/μs, V _{gr} =-2.5V, R _G =100Ω, T _c =80°C	—	—	15	μs
Thermal Resistance*	R _{th(j-c)}	DC	—	—	12	°C/W

* Junction to Case

GATE TRIGGERING CHARACTERISTICS

